



PATENT

THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:
Yian-Liang Kuo

Confirmation Number: 9795

Serial No.: 10/718,192

Group Art Unit: 2815
Examiner: Chu, Chris


Filed: 11/20/2003

TKHR Docket No. 252016-1720
Top-Team Ref. 0503-30125US

For: **A HEAT SPREADER BALL GRID ARRAY (HSBGA) DESIGN FOR LOW-K INTEGRATED CIRCUITS (IC)**

Certificate of Mailing

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail, postage prepaid, in an envelope addressed to: Mail Stop Amendment; Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on December 21, 2004.


Signature – Hui Chin Barnhill

AMENDMENT AND RESPONSE TO OFFICE ACTION

Mail Stop Amendment
Assistant Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

The non-final Office Action mailed September 22, 2004 has been carefully considered. In response thereto, please enter the following amendments and consider the following remarks.

In this regard, **Amendments to the Specification** begin on page 2; **Amendments to the Claims** begin on page 6, and **Remarks** begin on page 13 of this paper.